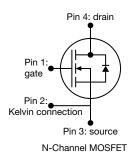


Vishay Siliconix

E Series Power MOSFET





PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	700				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.087				
Q _g max. (nC)	62				
Q _{gs} (nC)	16				
Q _{gd} (nC)	15				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



APPLICATIONS

- Server and telecom power supplies
- · Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	PowerPAK 8 x 8			
Lead (Pb)-free and halogen-free	SiHH100N65E-T1-GE3			

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V_{DS}	650		
Gate-source voltage			V_{GS}	± 30	V	
Continuous drain current (T _J = 150 °C)	V at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	28		
	V _{GS} at 10 V	T _C = 100 °C		18	Α	
Pulsed drain current ^a			I _{DM}	63		
Linear derating factor				1.47	W/°C	
Single pulse avalanche energy b			E _{AS}	127	mJ	
Maximum power dissipation			P_{D}	184	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope		dv/dt	100	1//		
Reverse diode dv/dt ^c			11	V/ns		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 3.0 A
- c. $I_{SD} \le I_D$, di/dt = 100 A/ μ s, starting T_J = 25 °C



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THERMAL RESISTANCE RATINGS						
PARAMETER SYMBOL TYP. MAX. UNIT						
Maximum junction-to-ambient	R _{thJA}	40	42	°C/W		
Maximum junction-to-case (drain)	R _{thJC}	0.51	0.68			

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•		•	•		
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	650	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.68	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3.0	-	5.0	V
Oala a a sa lada a a		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-source leakage	I_{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
7		V _{DS} =	: 650 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 520 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 12 A	-	0.087	0.100	Ω
Forward transconductance ^a	9 _{fs}	V_{DS}	= 8 V, I _D = 14 A	-	12	-	S
Dynamic		•					
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	2137	-	
Output capacitance	C _{oss}	Τ,	$V_{DS} = 100 \text{ V},$	-	89	-	1
Reverse transfer capacitance	C _{rss}	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	2	-	pF
Effective output capacitance, energy related ^a	C _{o(er)}			-	90	-	
Effective output capacitance, time related ^b	C _{o(tr)}			-	633	-	
Total gate charge	Qg			-	41	62	
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 14 A, V _{DS} = 520 V		-	16	-	nC
Gate-drain charge	Q_{gd}			-	15	-	1
Turn-on delay time	t _{d(on)}			-	28	56	
Rise time	t _r	V _{DD} = 520 V, I _D = 14 A,		-	68	136] no
Turn-off delay time	t _{d(off)}	V _{GS} =	$= 10 \text{ V}, R_g = 9.1 \Omega$	-	50	100	ns
Fall time	t _f			-	32	64	
Gate input resistance	R _g		f = 1 MHz	0.5	1.1	2.2	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	28	
Pulsed diode forward current	I _{SM}			-	-	63	A .
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 14 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}			-	362	724	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 14A,$ $di/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	5.0	10	μC
Reverse recovery current	I _{RRM}			_	22	_	A



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

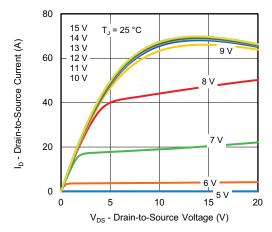


Fig. 1 - Typical Output Characteristics

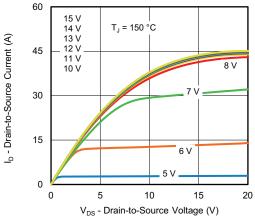


Fig. 2 - Typical Output Characteristics

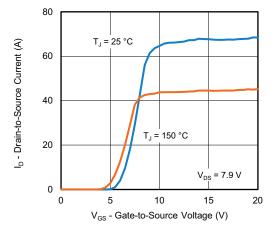


Fig. 3 - Typical Transfer Characteristics

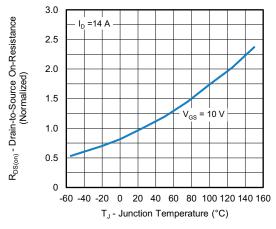


Fig. 4 - Normalized On-Resistance vs. Temperature

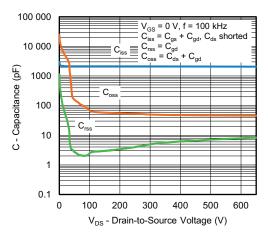


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

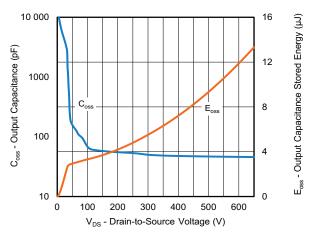


Fig. 6 - Coss and Eoss vs. VDS



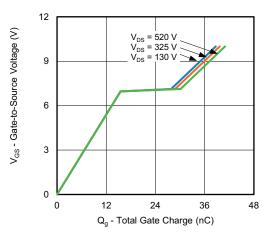


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

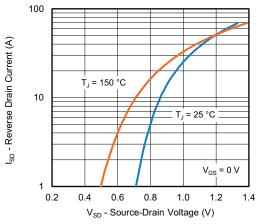


Fig. 8 - Typical Source-Drain Diode Forward Voltage

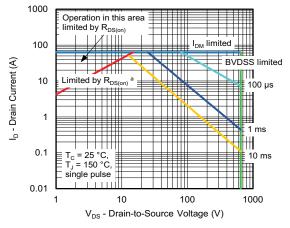


Fig. 9 - Maximum Safe Operating Area



a. V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

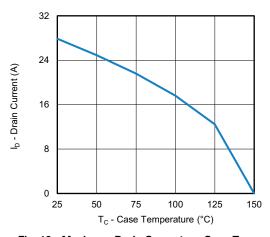


Fig. 10 - Maximum Drain Current vs. Case Temperature

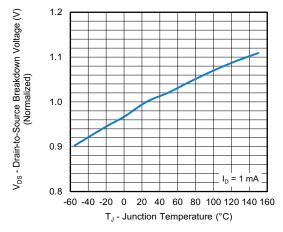


Fig. 11 - Temperature vs. Drain-to-Source Voltage



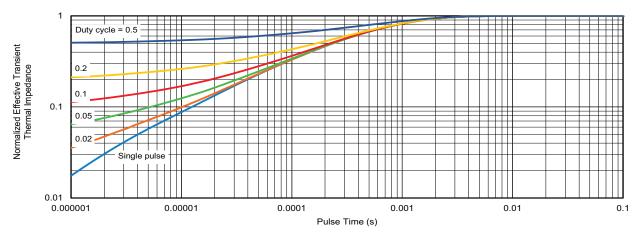


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

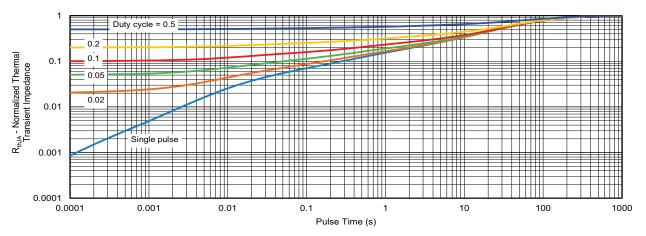


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

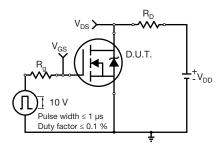


Fig. 14 - Switching Time Test Circuit

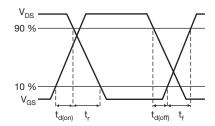


Fig. 15 - Switching Time Waveforms



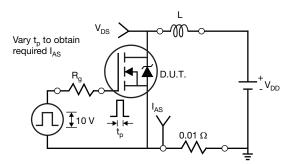


Fig. 16 - Unclamped Inductive Test Circuit

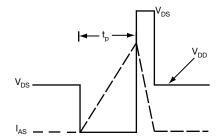


Fig. 17 - Unclamped Inductive Waveforms

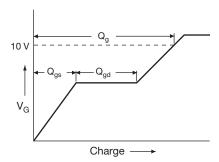


Fig. 18 - Basic Gate Charge Waveform

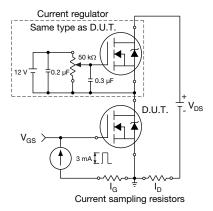
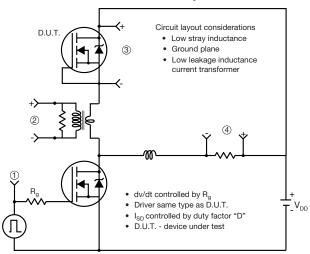


Fig. 19 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit



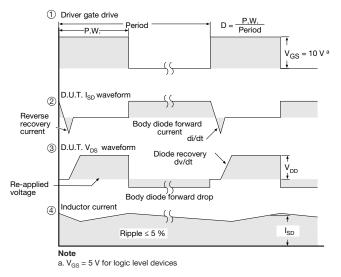


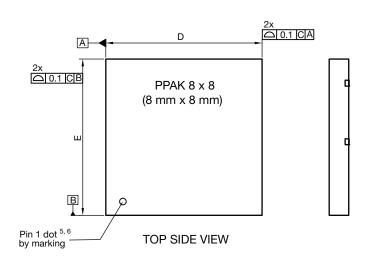
Fig. 20 - For N-Channel

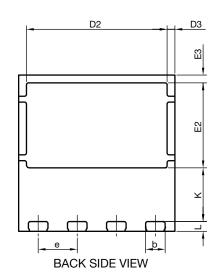
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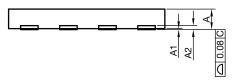


Vishay Siliconix

PowerPAK® 8 x 8 Case Outline







DIM	MILLIMETERS			INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2		020 ref.		0.008 ref.			
b	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3	0.40 BSC		0.016 BSC				
е		2.00 BSC		0.079 BSC			
Е	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3		0.40 BSC		0.016 BSC			
K	2.75 BSC		0.108 BSC				
L	0.45	0.50	0.55	0.018	0.020	0.022	
N ⁽³⁾	8				8		

Notes

- (1) Use millimeters as the primary measurement
- (2) Dimensioning and tolerances conform to ASME Y14.5 M 1994
- (3) N is the number of terminals
- (4) The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body
- (5) Exact shape and size of this feature is optional

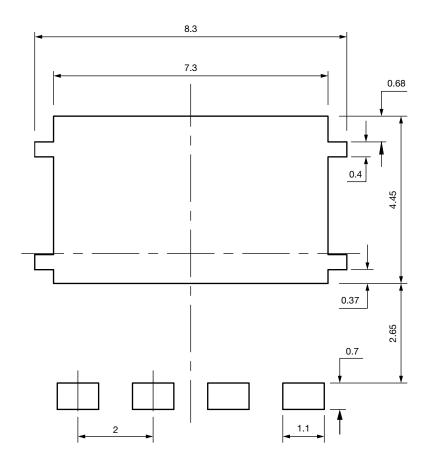
ECN: E20-0518-Rev. B, 28-Sep-2020

DWG: 6041

Revision: 28-Sep-2020 1 Document Number: 67859



Recommended Minimum PADs for PowerPAK® 8 mm x 8 mm



Dimensions in millimeters



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